

### FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

### MAXIMUM RATINGS

| Rating  | Symbol              | Value                    | Unit                   |
|---|---------------------|--------------------------|------------------------|
| <b>Peak repetitive off-state voltage<sup>(1)</sup></b><br>( $T_J = 110^\circ\text{C}$ )<br>BTC08-100(A)<br>BTC08-200(A)<br>BTC08-400(A)<br>BTC08-600(A) | $V_{\text{DRM}}$    | 100<br>200<br>400<br>600 | Volts                  |
| <b>RMS on-state current</b> ( $T_C = 72^\circ\text{C}$ )  | $I_{\text{T(RMS)}}$ | 8.0                      | Amps                   |
| <b>Peak surge current</b><br>(1 cycle, 50Hz, $T_J = -40$ to $+110^\circ\text{C}$ )  | $I_{\text{TSM}}$    | 60                       | Amps                   |
| <b>Circuit fusing considerations</b> ( $T_J = -40$ to $110^\circ\text{C}$ , $t = 10\text{ms}$ )   | $I^2t$              | 18                       | $\text{A}^2\text{s}$   |
| <b>Peak gate power</b> (pulse width = $10\mu\text{s}$ )   | $P_{\text{GM}}$     | 10                       | Watts                  |
| <b>Average gate power</b> ( $T_C = 80^\circ\text{C}$ , $t = 10\text{ms}$ )  | $P_{\text{G(AV)}}$  | 0.5                      | Watts                  |
| <b>Peak gate current</b> (pulse width = $10\mu\text{s}$ )   | $I_{\text{GM}}$     | 3.5                      | Amps                   |
| <b>Operating junction temperature range</b>   | $T_J$               | -40 to +110              | $^\circ\text{C}$       |
| <b>Storage temperature range</b>  | $T_{\text{stg}}$    | -40 to +150              | $^\circ\text{C}$       |
| <b><math>I_{\text{TM}} = 12\text{A}</math>, <math>I_{\text{G}} = 200\text{mA}</math></b>  | $di/dt$             | 10                       | $\text{A}/\mu\text{s}$ |

Note 1: Ratings apply for open gate conditions. Thyristor devices shall not be tested with a constant current source for blocking capability such that the voltage applied exceeds the rated blocking voltage.

Note 2: Soldering temperatures shall not exceed  $200^\circ\text{C}$  for 10 seconds.

### THERMAL CHARACTERISTICS

| Characteristic                                 | Symbol                | Maximum | Unit                      |
|--|-----------------------|---------|---------------------------|
| <b>Thermal resistance, junction to case</b>    | $R_{\theta\text{JC}}$ | 2.2     | $^\circ\text{C}/\text{W}$ |
| <b>Thermal resistance, junction to ambient</b> | $R_{\theta\text{JA}}$ | 60      | $^\circ\text{C}/\text{W}$ |

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic   | Symbol           | Min | Typ. | Max       | Unit  |
|--|------------------|-----|------|-----------|-------|
| <b>Peak blocking current</b> (either direction)<br>(Rated $V_{\text{DRM}}$ @ $T_J = 110^\circ\text{C}$ , gate open)  | $I_{\text{DRM}}$ | -   | -    | 1.0       | mA    |
| <b>Peak on-state voltage</b> (either direction)<br>( $I_{\text{TM}} = 10\text{A}$ peak)  | $V_{\text{TM}}$  | -   | 1.5  | 1.75      | Volts |
| <b>Gate trigger voltage</b> (continuous dc)<br>(main terminal voltage = $12\text{V}$ , $R_L = 100\Omega$ )<br>All types, all quadrants<br>(main terminal voltage = rated $V_{\text{DRM}}$ , $R_L = 10\text{k}\Omega$ , $T_J = 110^\circ\text{C}$ )<br>All types, all quadrants | $V_{\text{GTM}}$ | -   | -    | 2.5       | Volts |
| <b>Holding current</b> (either direction)<br>(main terminal source voltage = $12\text{V}$ , gate open, initiating current = $1.0\text{A}$ )<br>$T_C = -40^\circ\text{C}$<br>$T_C = 25^\circ\text{C}$   | $I_{\text{H}}$   | -   | -    | 100<br>45 | mA    |

# BTC08-(A) SERIES

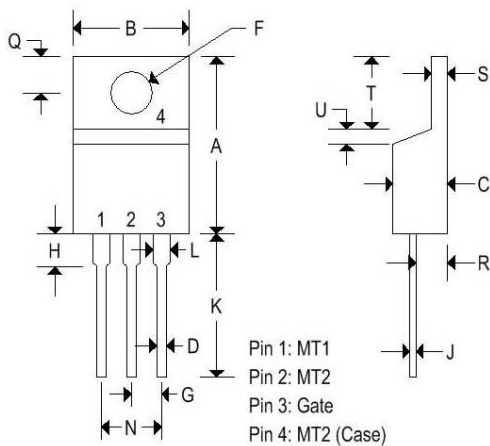
## SILICON BIDIRECTIONAL THYRISTORS

|  |          |    |     |     |      |
|--|----------|----|-----|-----|------|
| <b>Latching current</b><br>(main terminal source voltage = 24V, gate trigger source = 15V, 100Ω)<br>MT2(+), G(+)<br>MT2(-), G(-)<br>MT2(+), G(-) | $I_L$    | -  | -   | 100 | mA   |
| <b>Critical rate of rise of off-state voltage</b><br>(Rated $V_{DRM}$ , exponential voltage rise, gate open, $T_C = 100^\circ\text{C}$ )         | dv/dt    | 50 | 100 | -   | V/μs |
| <b>Blocking voltage application rate at commutation</b><br>(@ $V_{DRM}$ , gate open commutating di/dt = 3.2A/ms)                                 | dv/dt(c) | 4  | -   | -   | V/μs |

| Characteristic  | Symbol    | QUADRANT               |                        |                        |                      |
|---|-----------|------------------------|------------------------|------------------------|----------------------|
|   |           | I<br>mA                | II<br>mA               | III<br>mA              | IV<br>mA             |
| <b>Peak gate trigger current</b><br>(main terminal voltage = 12V, $R_L = 100\Omega$ )<br>BTC08 SERIES, $T_J = 25^\circ\text{C}$<br>BTC08 SERIES, $T_J = -40^\circ\text{C}$<br>BTC08-(A) SERIES, $T_J = 25^\circ\text{C}$<br>BTC08-(A) SERIES, $T_J = -40^\circ\text{C}$ | $I_{GTM}$ | 50<br>100<br>50<br>100 | 50<br>100<br>50<br>100 | 50<br>100<br>50<br>100 | -<br>-<br>100<br>200 |

### MECHANICAL CHARACTERISTICS

|                |               |
|----------------|---------------|
| <b>Case</b>    | TO-220AB      |
| <b>Marking</b> | Alpha-numeric |
| <b>Pin out</b> | See below     |



|   | TO-220AB |       |             |        |
|---|----------|-------|-------------|--------|
|   | Inches   |       | Millimeters |        |
|   | Min      | Max   | Min         | Max    |
| A | 0.575    | 0.620 | 14.600      | 15.750 |
| B | 0.380    | 0.405 | 9.650       | 10.290 |
| C | 0.160    | 0.190 | 4.060       | 4.820  |
| D | 0.025    | 0.035 | 0.640       | 0.890  |
| F | 0.142    | 0.147 | 3.610       | 3.730  |
| G | 0.095    | 0.105 | 2.410       | 2.670  |
| H | 0.110    | 0.155 | 2.790       | 3.930  |
| J | 0.014    | 0.022 | 0.360       | 0.560  |
| K | 0.500    | 0.562 | 12.700      | 14.270 |
| L | 0.045    | 0.055 | 1.140       | 1.390  |
| N | 0.190    | 0.210 | 4.830       | 5.330  |
| Q | 0.100    | 0.120 | 2.540       | 3.040  |
| R | 0.080    | 0.110 | 2.040       | 2.790  |
| S | 0.045    | 0.055 | 1.140       | 1.390  |
| T | 0.235    | 0.255 | 5.970       | 6.460  |
| U | -        | 0.050 | -           | 1.270  |
| V | 0.045    | -     | 1.140       | -      |
| Z | -        | 0.080 | -           | 2.030  |

# BTC08-(A) SERIES

## SILICON BIDIRECTIONAL THYRISTORS

FIGURE 1 – RMS CURRENT DERATING (f = 50 Hz)

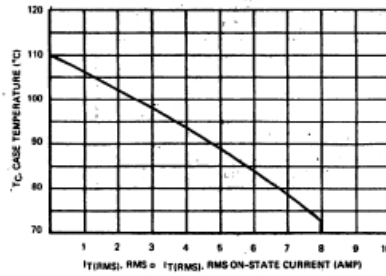


FIGURE 2 – MAXIMUM ON-STATE CHARACTERISTICS

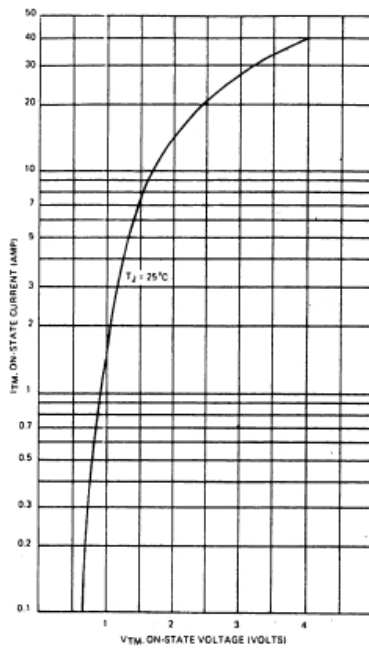
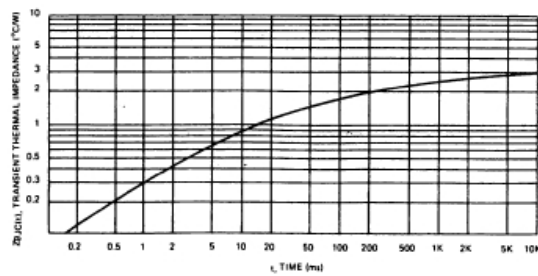


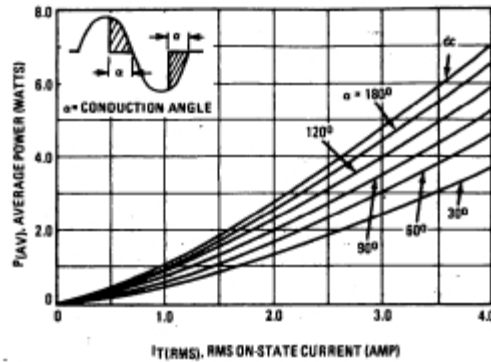
FIGURE 3 – THERMAL RESPONSE



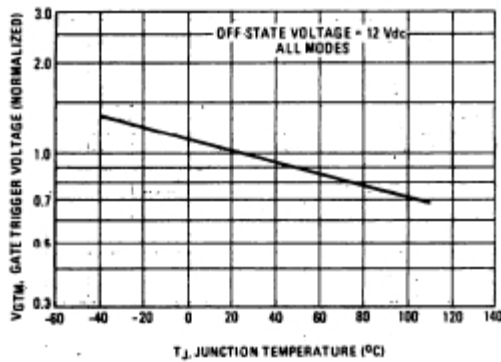
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## SILICON BIDIRECTIONAL THYRISTORS

**FIGURE 4 – TYPICAL HOLDING CURRENT**



**FIGURE 5 – TYPICAL GATE-TRIGGER VOLTAGE**



**FIGURE 6 – TYPICAL GATE-TRIGGER CURRENT**

